

# One Watt High Voltage Transistor

# **PNP Silicon**

• This device is available in Pb-free package(s). Specifications herein apply to both standard and Pb-free devices. Please see our website at www.onsemi.com for specific Pb-free orderable part numbers, or contact your local ON Semiconductor sales office or representative.

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V <sub>CEO</sub>	-300	Vdc
Collector - Base Voltage	V <sub>CBO</sub>	-300	Vdc
Emitter - Base Voltage	V <sub>EBO</sub>	-5.0	Vdc
Collector Current — Continuous	I <sub>C</sub>	-500	mAdc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	1.0 8.0	Watt mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	2.5 20	Watts mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	125	°C/W
Thermal Resistance, Junction to Case	$R_{ heta JC}$	50	°C/W

### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

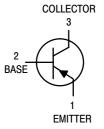
Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector – Emitter Breakdown Voltage <sup>(1)</sup> $ (I_C = -1.0 \text{ mAdc}, I_B = 0) $	V <sub>(BR)CEO</sub>	-300	_	Vdc
Collector–Base Breakdown Voltage ( $I_C = -100 \mu Adc$ , $I_E = 0$ )	V <sub>(BR)CBO</sub>	-300	_	Vdc
Emitter–Base Breakdown Voltage $(I_E = -100 \ \mu Adc, \ I_C = 0)$	V <sub>(BR)EBO</sub>	-5.0	_	Vdc
Collector Cutoff Current (V <sub>CB</sub> = -200 Vdc, I <sub>E</sub> = 0)	I <sub>CBO</sub>	_	-0.25	μAdc
Emitter Cutoff Current (V <sub>EB</sub> = -3.0 Vdc, I <sub>C</sub> = 0)	I <sub>EBO</sub>	=	-0.1	μAdc

<sup>1.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

# **MPSW92**

**ON Semiconductor Preferred Device** 





Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted) (Continued)

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Characteristic	Symbol	Min	Max	Unit
ON CHARACTERISTICS <sup>(1)</sup>	•			
DC Current Gain $ \begin{aligned} &(I_C = -1.0 \text{ mAdc, } V_{CE} = -10 \text{ Vdc)} \\ &(I_C = -10 \text{ mAdc, } V_{CE} = -10 \text{ Vdc)} \\ &(I_C = -30 \text{ mAdc, } V_{CE} = -10 \text{ Vdc)} \end{aligned} $	h <sub>FE</sub>	25 40 25	_ _ _	_
Collector–Emitter Saturation Voltage (I <sub>C</sub> = -20 mAdc, I <sub>B</sub> = -2.0 mAdc)	V <sub>CE(sat)</sub>	_	-0.5	Vdc
Base-Emitter Saturation Voltage (I <sub>C</sub> = -20 mAdc, I <sub>B</sub> = -2.0 mAdc)	V <sub>BE(sat)</sub>	_	-0.9	Vdc
SMALL-SIGNAL CHARACTERISTICS	•	•	•	•
Current-Gain — Bandwidth Product (I <sub>C</sub> = -10 mAdc, V <sub>CE</sub> = -20 Vdc, f = 20 MHz)	f <sub>T</sub>	50	_	MHz
Collector-Base Capacitance (V <sub>CB</sub> = -20 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	C <sub>cb</sub>	_	6.0	pF

<sup>1.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

#### MPSW92

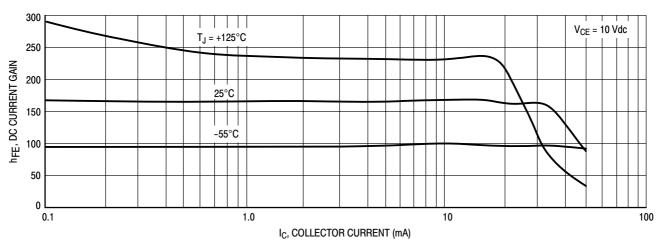


Figure 1. DC Current Gain

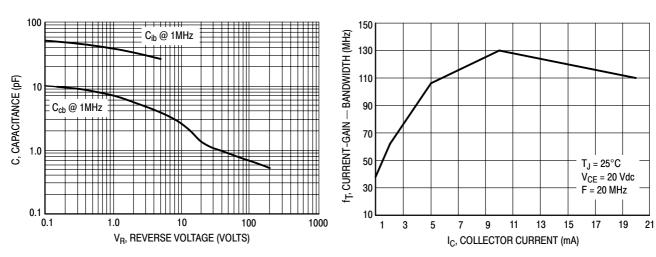
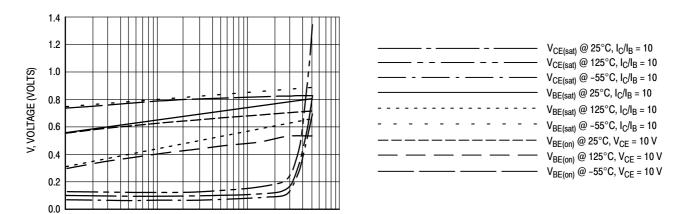


Figure 2. Capacitance



100

Figure 3. Current-Gain — Bandwidth

I<sub>C</sub>, COLLECTOR CURRENT (mA)

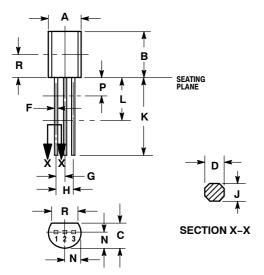
Figure 4. "ON" Voltages

0.1

### MPSW92

#### PACKAGE DIMENSIONS

#### TO-92 (TO-226) **CASE 29-10** ISSUF AL



YLE 1:

PIN 1. EMITTER BASE

COLLECTOR

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. CONTOUR OF PACKAGE BEYOND DIMENSION R
- IS UNCONTROLLED.

  4. DIMENSION F APPLIES BETWEEN P AND L.
- DIMENSIONS D AND J APPLY BETWEEN L AND K MIMIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.44	5.21	
В	0.290	0.310	7.37	7.87	
С	0.125	0.165	3.18	4.19	
D	0.018	0.021	0.457	0.533	
F	0.016	0.019	0.407	0.482	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.018	0.024	0.46	0.61	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
Р		0.100		2.54	
R	0.135		3.43		

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